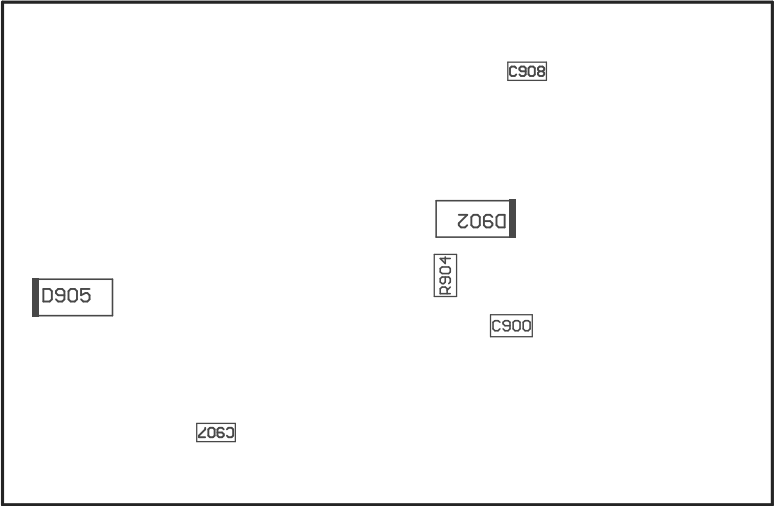


PCB VIEWED FROM TOP SIDE	BOARD #: PMP10866	REV: A	SVN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 2/12/2015 4:10:43 PM		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP10866	REV: A	SUN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/12/2015 4:10:44 PM	TEXAS INSTRUMENTS	

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